

IN THE CLAIMS

This listing of claims will replace all prior versions, and listings, of claims in the application:

1 1. (Currently Amended) A current-in-plane (CIP) GMR sensor, comprising:
2 a GMR sensor stack having a width selected to provide a predetermined track
3 width;
4 a spacer layer, having a width substantially equal to the spin valve stack, formed
5 over a free-layer of the GMR sensor stack; and
6 an in-stack biasing layer disposed over the spacer and having a width substantially
7 equal to the width of the GMR sensor stack.

1 2. (Currently Amended) The CIP GMR sensor of claim 1, wherein the in-
2 stack biasing layer comprises materials selected from the group consisting of NiFe, CoFe,
3 NiFeCr, NiFe_x and CoFe_x NiFeX and CoFeX.

1 3. (Currently Amended) The CIP GMR sensor of claim 1 further comprising
2 lead layers formed on either side of the GMR sensor stack an antiferromagnetic layer
3 formed on both sides of the in-stack biasing layer to provide an off-track bias layer.

1 4. (Currently Amended) The CIP GMR sensor of claim 3, further comprising
2 lead layers formed on either side of the GMR sensor stack, wherein the lead layers
3 comprises a layer of Rhodium disposed adjacent to the GMR sensor stack; and a
4 Tantalum layer formed over the layer of Rhodium and a layer of Platinum Manganese
5 formed over the layer of Tantalum.

1 5. (Currently Amended) The CIP GMR sensor of claim [[4]] 3, wherein the
2 antiferromagnetic layer comprises a layer of Platinum-Manganese ~~is formed adjacent a~~
3 portion of the in-stack bias layer.

1 6. (Currently Amended) The CIP GMR sensor of claim 3, wherein the in-
2 stack biasing layer comprises a bias layer formed only over the spacer and a coupling
3 layer formed over the bias layer and the antiferromagnetic layer of Platinum-Manganese.

1 7. (Currently Amended) The CIP GMR sensor of claim 6, wherein the bias
2 layers and coupling layer each comprise a material selected from the group consisting of
3 NiFe, CoFe, NiFeCr, NiFe_x and CoFe_x NiFeX and CoFeX.

1 8. (Original) The CIP GMR sensor of claim 1 further comprising a cap
2 layer formed over the in-stack bias layer.

1 9. (Currently Amended) A magnetic storage system, comprising:
2 a magnetic storage medium having a plurality of tracks for recording of data; and
3 a current-in-plane (CIP) GMR sensor maintained in a closely spaced position
4 relative to the magnetic storage medium during relative motion between the magnetic
5 transducer and the magnetic storage medium, the CIP GMR sensor further comprising:
6 a GMR sensor stack having a width selected to provide a predetermined
7 track width;
8 a spacer layer, having a width substantially equal to the spin valve stack,
9 formed over a free-layer of the GMR sensor stack; and
10 an in-stack biasing layer disposed over the spacer and having a width
11 substantially equal to the width of the GMR sensor stack.

1 10. (Currently Amended) The magnetic storage of claim 9, wherein the in-
2 stack biasing layer comprises materials selected from the group consisting of NiFe, CoFe,
3 NiFeCr, ~~NiFe_x and CoFe_x~~ NiFeX and CoFeX.

1 11. (Currently Amended) The magnetic storage of claim 9 further comprising
2 lead layers formed on either side of the GMR sensor stack an antiferromagnetic layer
3 formed on both sides of the in-stack biasing layer to provide an off-track bias layer.

1 12. (Currently Amended) The magnetic storage of claim 11, , further
2 comprising lead layers formed on either side of the GMR sensor stack, wherein the lead
3 layers comprises a layer of Rhodium disposed adjacent to the GMR sensor stack, and a
4 Tantalum layer formed over the layer of Rhodium ~~and a layer of Platinum-Manganese~~
5 ~~formed over the layer of Tantalum~~.

1 13. (Currently Amended) The magnetic storage of claim [[12]] 11, wherein
2 the antiferromagnetic layer comprises a layer of Platinum-Manganese is formed adjacent
3 a portion of the in-stack bias layer.

1 14. (Currently Amended) The magnetic storage of claim 11, wherein the in-
2 stack biasing layer comprises a bias layer formed only over the spacer and a coupling
3 layer formed over the bias layer and the antiferromagnetic layer of Platinum-Manganese.

1 15. (Currently Amended) The magnetic storage of claim 9, wherein the bias
2 layer and the coupling layer each comprise a material selected from the group consisting
3 of NiFe, CoFe, NiFeCr, NiFe_x and CoFe_x NiFeX and CoFeX.

1 16. (Original) The magnetic storage of claim 9 further comprising a cap
2 layer formed over the in-stack bias layer.

1 17. (Currently Amended) A method for providing a current-in-plane (CIP)
2 GMR sensor with an improved in-stack bias layer with a thinner sensor stack,
3 comprising:
4 forming a thin spin valve stack having a width selected to provide a
5 predetermined track width;
6 forming a spacer over the spin valve stack, the spacer having a width substantially
7 equal to the spin valve stack;
8 forming lead layers in a passive region outside the track;
9 forming, over the spacer, an in-stack bias layer having a width substantially equal
10 to the width of the GMR sensor stack over the spacer for biasing a free-layer of the spin
11 valve stack; and
12 forming a cap over the bias layer.

1 18. (Currently Amended) The method of claim 17, wherein forming the lead
2 layers further comprises forming a layer of Rhodium disposed adjacent to the GMR
3 sensor stack; and forming a Tantalum layer formed over the layer of Rhodium ~~and a layer~~
4 ~~of Platinum Manganese formed over the layer of Tantalum~~.

1 19. (Currently Amended) The method of claim [[18]] 17, wherein the
2 forming of the in-stack bias layer comprises forming a layer of Platinum-Manganese
3 ~~further comprises forming the layer of Platinum Manganese adjacent a portion of the in-~~
4 ~~stack bias layer~~.

1 20. (Currently Amended) The method of claim [[18]] 17, wherein the in-
2 stack bias layer comprises a bias layer formed only over the spacer and a coupling layer
3 formed over the bias layer and the antiferromagnetic layer of Platinum-Manganese.

1 21. (Currently Amended) The method of claim 17, wherein the forming of the
2 bias layer and the coupling layer each further comprises using a material selected from
3 the group consisting of NiFe, CoFe, NiFeCr, NiFe_x and CoFe_x NiFeX and CoFeX.